

MBRF30100CTL

Technical Data Data Sheet N0852, Rev. -

Green Products

MBRF30100CTL SCHOTTKY RECTIFIER

Applications:

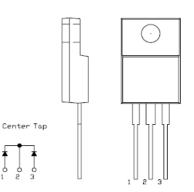
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Features:

- 150 ℃ TJ operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device

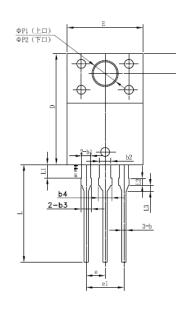
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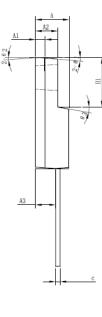
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

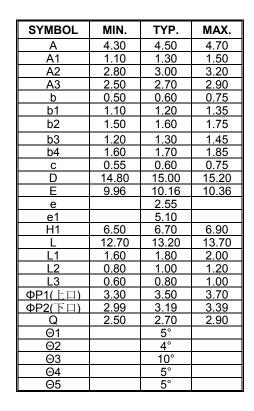


OUTLINE DRAWING

Mechanical Dimensions: In mm







ITO-220AB(HD)

- China Germany Korea Singapore United States •
- http://www.smc-diodes.com sales@ smc-diodes.com •



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Marking Diagram:



Where XXXXX is YYWWL

MBR F 30 100 CTL SSG YY WW	 Device Type Package type Forward Current (30A) Reverse Voltage (100V) Configuration SSG Year Week
L	= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
MBRF30100CTL	ITO-220AB (Pb-Free)	50pcs / tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V _{RWM}	-	100	V
Average Forward Current (per device)	I _{F(AV)}	50% duty cycle @T _C = 135°C, rectangular wave form	30	А
Peak One Cycle Non- Repetitive Surge Current (per leg)	I _{FSM}	8.3 ms, half Sine pulse	280	А

China - Germany - Korea - Singapore - United States http://www.smc-diodes.com - sales@ smc-diodes.com -



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Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Forward Voltage Drop	V _{F1}	@ 15 A, Pulse, T _J = 25 °C	0.80	V
(per leg) *	V _{F2}	@ 15 A, Pulse, T _J = 125 °C	0.75	V
Reverse Current (per leg) *	I _{R1}	@V _R = rated V _R T _J = 25 °C	1.00	mA
	I _{R2}	@V _R = rated V _R T _J = 125 °C	40.0	mA
Junction Capacitance (per leg)	CT	@V _R = 5V, T _C = 25 °C f _{SIG} = 1MHz	400	pF
RSM Isolation Voltage (t = 1.0 second, R. H. < =30%, T _A = 25 °C)	V _{ISO}	Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction.	4500	V
		Clip mounting, the epoxy body is inside the heatsink.	3500	
		Screw mounting, the epoxy body is inside the heatsink.	1500	

* Pulse Width < 300 μ s, Duty Cycle <2%

Thermal-Mechanical Specifications:

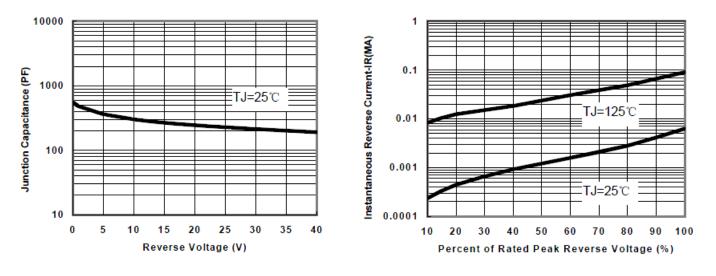
Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-65 to +150	°C
Storage Temperature	T _{stg}	-	-65 to +150	°C
Maximum Thermal Resistance Junction to Case	R _{θJC}	DC operation	3.5	°C/W
Maximum Thermal Resistance, Case to Heat Sink	$R_{ ext{ heta}JA}$	DC operation	50	°C/W
Approximate Weight	wt	-	2	g
Case Style		ITO-220AB		



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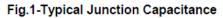


Fig.2-Typical Reverse Characteristics

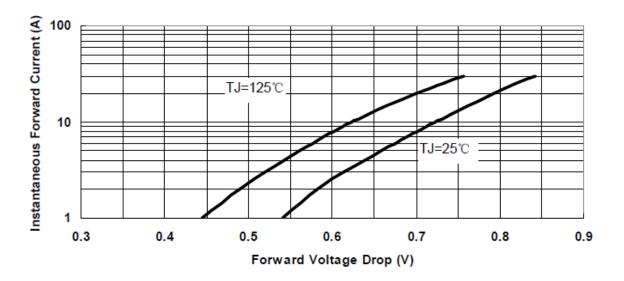


Fig.3-Typical Instantaneous Forward Voltage Characteristics



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